

## Low Cost DDR Phase Lock Loop Zero Delay Buffer

**Recommended Application:**  
DDR Zero Delay Clock Buffer

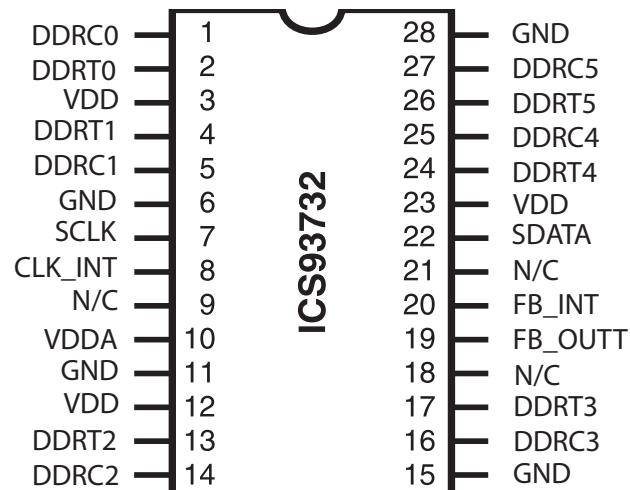
**Product Description/Features:**

- Low skew, low jitter PLL clock driver
- Max frequency supported = 266MHz (DDR 533)
- I<sup>2</sup>C for functional and output control
- Feedback pins for input to output synchronization
- Spread Spectrum tolerant inputs
- 3.3V tolerant CLK\_INT input

**Switching Characteristics:**

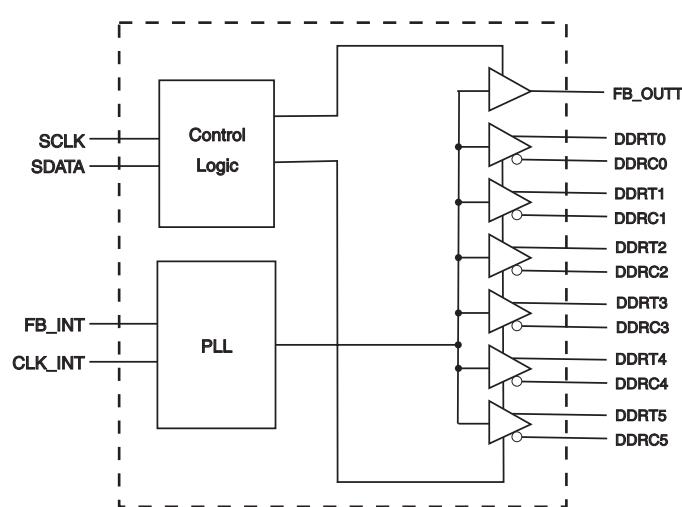
- CYCLE - CYCLE jitter (66MHz): <120ps
- CYCLE - CYCLE jitter (>100MHz): <65ps
- CYCLE - CYCLE jitter (>200MHz): <75ps
- OUTPUT - OUTPUT skew: <100ps
- DUTY CYCLE: 49.5% - 50.5%

**Pin Configuration**



28-pin 209mil SSOP

**Block Diagram**



**Functionality**

AVDD	CLK_INT	OUTPUTS			PLL State
		CLKT	CLKC	FB_OUTT	
2.5V (nom)	L	L	H	L	on
2.5V (nom)	H	H	L	H	on

## Pin Descriptions

PIN #	PIN NAME	PIN TYPE	DESCRIPTION
1	DDRC0	OUT	"Complimentary" Clock of differential pair output.
2	DDRT0	OUT	"True" Clock of differential pair output.
3	VDD	PWR	Power supply, nominal 2.5V
4	DDRT1	OUT	"True" Clock of differential pair output.
5	DDRC1	OUT	"Complimentary" Clock of differential pair output.
6	GND	PWR	Ground pin.
7	SCLK	IN	Clock pin of I2C circuitry 5V tolerant
8	CLK_INT	IN	"True" reference clock input.
9	N/C	N/C	No Connection.
10	VDDA	PWR	2.5V power for the PLL core.
11	GND	PWR	Ground pin.
12	VDD	PWR	Power supply, nominal 2.5V
13	DDRT2	OUT	"True" Clock of differential pair output.
14	DDRC2	OUT	"Complimentary" Clock of differential pair output.
15	GND	PWR	Ground pin.
16	DDRC3	OUT	"Complimentary" Clock of differential pair output.
17	DDRT3	OUT	"True" Clock of differential pair output.
18	N/C	N/C	No Connection.
19	FB_OUT	OUT	Feedback output, dedicated for external feedback.
20	FB_INT	IN	True single-ended feedback input, provides feedback signal to internal PLL for synchronization with CLK_INT to eliminate phase error.
21	N/C	N/C	No Connection.
22	SDATA	I/O	Data pin for I2C circuitry 5V tolerant
23	VDD	PWR	Power supply, nominal 2.5V
24	DDRT4	OUT	"True" Clock of differential pair output.
25	DDRC4	OUT	"Complimentary" Clock of differential pair output.
26	DDRT5	OUT	"True" Clock of differential pair output.
27	DDRC5	OUT	"Complimentary" Clock of differential pair output.
28	GND	PWR	Ground pin.

## Absolute Maximum Ratings

Supply Voltage (VDD & AVDD) . . . . .	-0.5V to 3.6V
Logic Inputs . . . . .	GND -0.5 V to V <sub>DD</sub> +0.5 V
Ambient Operating Temperature . . . . .	0°C to +85°C
Case Temperature . . . . .	115°C
Storage Temperature . . . . .	-65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## Recommended Operation Conditions

T<sub>A</sub> = 0 - 70°C; Supply Voltage AV<sub>DD</sub>, V<sub>DD</sub> = 2.50V ± 0.20V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Analog / Core Supply Volta	AV <sub>DD</sub>		2.3	2.5	2.7	V
Input Voltage Level	V <sub>IN</sub>		2	2.5	3	V
Output Differential Pair Crossing Voltage	V <sub>OC</sub>	66/100/133/166MHz, V <sub>DD</sub> =2.50V	1.23	1.25	1.32	V

## Electrical Characteristics - Input / Supply / Common Output parameters

T<sub>A</sub> = 0 - 70°C; Supply Voltage AV<sub>DD</sub>, V<sub>DD</sub> = 2.50V ± 0.20V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Supply Current	I <sub>DD2.5</sub>	R <sub>T</sub> = 120W, C <sub>L</sub> = 12 pF at 100MHz		236	300	mA
		R <sub>T</sub> = 120W, C <sub>L</sub> = 12 pF at 133MHz		263	300	
	I <sub>DDPD</sub>	CL=0 pF			100	mA
Output High Current	I <sub>OH</sub>	V <sub>DD</sub> = 2.5V, V <sub>OUT</sub> = 1V	-48	-33	-29	mA
Output Low Current	I <sub>OL</sub>	V <sub>DD</sub> = 2.5V, V <sub>OUT</sub> = 1.2V	29	33	37	mA
High Impedance Ouptut Current	I <sub>OZ</sub>	V <sub>DD</sub> = 2.7V, V <sub>OUT</sub> = V <sub>DD</sub> or GND			10	mA
High-level Output Voltage	V <sub>OH</sub>	V <sub>DD</sub> = min to max, I <sub>OH</sub> = -1mA	2	2.25		V
		V <sub>DD</sub> = 2.3V, I <sub>OH</sub> = -12mA		1.95		
Low-level Output Voltage	V <sub>OL</sub>	V <sub>DD</sub> = min to max, I <sub>OH</sub> = 1mA		0.05	0.1	V
		V <sub>DD</sub> = 2.3V, I <sub>OH</sub> = 12mA		0.3	0.4	
Output Capacitance <sup>1</sup>	C <sub>OUT</sub>	V <sub>I</sub> = V <sub>DD</sub> or GND		3		pF

1. Guaranteed by design, not 100% tested in production.

## Timing Requirements

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $AV_{DD}, V_{DD} = 2.50\text{V}$  (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Clock Frequency	$freq_{op}$	Input Voltage level: 0-2.50V	22		340	MHz
Input Clock Duty Cycle <sup>1</sup>	$d_{tin}$		40	50	60	%
Clock Stabilization <sup>1</sup>	$t_{STAB}$	from $VDD = 2.5\text{V}$ to 1% target frequency			100	$\mu\text{s}$

1. Guaranteed by design, not 100% tested in production.

## Switching Characteristics

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $AV_{DD}, V_{DD} = 2.50\text{V} \pm 0.20\text{V}$  (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Cycle to cycle Jitter <sup>1,2</sup>	$t_{c-c}$	66 MHz		100	120	ps
		100 / 125/ 133/167MHz		48	65	
		200/267MHz		47	75	
Phase Error <sup>1</sup>	$t_{pe}$		-150		150	ps
Output to output Skew <sup>1</sup>	$T_{skew}$			20	100	ps
Duty Cycle (Sign Ended) <sup>1,3</sup>	DC	66 MHz to 100MHz	49.5	50	50.5	%
		101MHz to 267 MHz	49	49.4	51	%
Rise Time, Fall Time <sup>4</sup>	$t_R, t_f$	Load=120 $\Omega$ /14pF		579	950	ps

### Notes:

1. Refers to transition on noninverting output.
2. While the pulse skew is almost constant over frequency, the duty cycle error increases at higher frequencies. This is due to the formula: duty cycle =  $t_{wH}/t_c$ , where the cycle ( $t_c$ ) decreases as the frequency goes up.

## General I<sup>2</sup>C serial interface information

The information in this section assumes familiarity with I<sup>2</sup>C programming.  
For more information, contact ICS for an I<sup>2</sup>C programming application note.

### How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D4<sub>(H)</sub>
- ICS clock will **acknowledge**
- Controller (host) sends a dummy command code
- ICS clock will **acknowledge**
- Controller (host) sends a dummy byte count
- ICS clock will **acknowledge**
- Controller (host) starts sending first byte (Byte 0) through byte 6
- ICS clock will **acknowledge** each byte **one at a time**.
- Controller (host) sends a Stop bit

How to Write:	
Controller (Host)	ICS (Slave/Receiver)
Start Bit	
Address D4 <sub>(H)</sub>	<b>ACK</b>
Dummy Command Code	<b>ACK</b>
Dummy Byte Count	<b>ACK</b>
Byte 0	<b>ACK</b>
Byte 1	<b>ACK</b>
Byte 2	<b>ACK</b>
Byte 3	<b>ACK</b>
Byte 4	<b>ACK</b>
Byte 5	<b>ACK</b>
Byte 6	<b>ACK</b>
Stop Bit	

### How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the read address D5<sub>(H)</sub>
- ICS clock will **acknowledge**
- ICS clock will send the **byte count**
- Controller (host) acknowledges
- ICS clock sends first byte (**Byte 0**) through **byte 6**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a stop bit

How to Read:	
Controller (Host)	ICS (Slave/Receiver)
Start Bit	
Address D5 <sub>(H)</sub>	<b>ACK</b>
	<b>Byte Count</b>
	<b>ACK</b>
	<b>Byte 0</b>
	<b>ACK</b>
	<b>Byte 1</b>
	<b>ACK</b>
	<b>Byte 2</b>
	<b>ACK</b>
	<b>Byte 3</b>
	<b>ACK</b>
	<b>Byte 4</b>
	<b>ACK</b>
	<b>Byte 5</b>
	<b>ACK</b>
	<b>Byte 6</b>
	Stop Bit

### Notes:

1. The ICS clock generator is a slave/receiver, I<sup>2</sup>C component. It can read back the data stored in the latches for verification. **Read-Back will support Intel PIIX4 "Block-Read" protocol**.
2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
3. The input is operating at 3.3V logic levels.
4. The data byte format is 8 bit bytes.
5. To simplify the clock generator I<sup>2</sup>C interface, the protocol is set to use only "**Block-Writes**" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, but the data is ignored for those two bytes. The data is loaded until a Stop sequence is issued.
6. At power-on, all registers are set to a default condition, as shown.

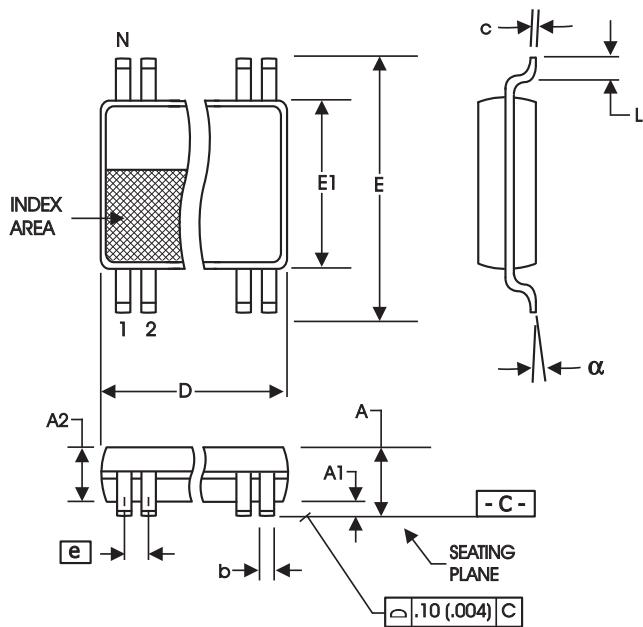
**Bytes 0 to 4 are reseved power up default = 1. This allows operation with main clock.**

BYTE 5	Affected Pin		Control Function	Type	Bit Control			PWD
	Pin #	Name			0	1		
Bit 7	2, 1	DDR0(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 6	4, 5	DDR1(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 5	-	-	Reserved	X	-	-		1
Bit 4	-	-	Reserved	X	-	-		1
Bit 3	13, 14	DDR2(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 2	17, 16	DDR3(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 1	-	-	Reserved	X	-	-		1
Bit 0	-	-	Reserved	X	-	-		1

Note: PWD = Power Up Default

BYTE 6	Affected Pin		Control Function	Type	Bit Control			PWD
	Pin #	Name			0	1		
Bit 7	-	-	Reserved	X	-	-		0
Bit 6	-	-	Reserved	X	-	-		0
Bit 5	-	-	Reserved	X	-	-		0
Bit 4	-	-	Reserved	X	-	-		1
Bit 3	24, 25	DDR4(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 2	-	-	Reserved	X	-	-		1
Bit 1	26, 27	DDR5(T&C)	Output Control	RW	DISABLE	ENABLE		1
Bit 0	-	-	Reserved	X	-	-		1

Note: PWD = Power Up Default



SYMBOL	In Millimeters		In Inches	
	COMMON DIMENSIONS MIN	COMMON DIMENSIONS MAX	COMMON DIMENSIONS MIN	COMMON DIMENSIONS MAX
A	--	2.00	--	.079
A1	0.05	--	.002	--
A2	1.65	1.85	.065	.073
b	0.22	0.38	.009	.015
c	0.09	0.25	.0035	.010
D	SEE VARIATIONS		SEE VARIATIONS	
E	7.40	8.20	.291	.323
E1	5.00	5.60	.197	.220
e	0.65	BASIC	0.0256	BASIC
L	0.55	0.95	.022	.037
N	SEE VARIATIONS		SEE VARIATIONS	
$\alpha$	0°	8°	0°	8°

#### VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.90	10.50	.390	.413

Reference Doc.: JEDEC Publication 95, MO-150  
10-0033

209 mil SSOP

## Ordering Information

ICS93732yFLFT

Example:

ICS XXXX y F LFT

- Designation for tape and reel packaging
- RoHS Compliant
- Package Type  
F = SSOP
- Revision Designator (will not correlate with datasheet revision)
- Device Type
- Prefix

ICS = Standard Device

**Revision History**

<b>Rev.</b>	<b>Issue Date</b>	<b>Description</b>	<b>Page #</b>
I	5/18/2005	Added LF Ordering Information to TSSOP package.	8
J	6/20/2008	Removed TSSOP Ordering Information.	-

## IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01)

### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

### Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit [www.renesas.com/contact-us/](http://www.renesas.com/contact-us/).